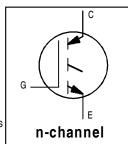
# International Rectifier

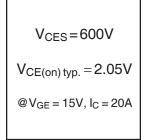
# IRG4PC40WPbF

### INSULATED GATE BIPOLAR TRANSISTOR

#### **Features**

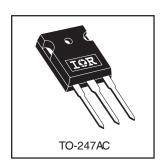
- Designed expressly for Switch-Mode Power Supply and PFC (power factor correction) applications
- Industry-benchmark switching losses improve efficiency of all power supply topologies
- 50% reduction of Eoff parameter
- Low IGBT conduction losses
- Latest-generation IGBT design and constructionoffers tighter parameters distribution, exceptional reliability
- Lead-Free





#### **Benefits**

- Lower switching losses allow more cost-effective operation than power MOSFETs up to 150 kHz ("hard switched" mode)
- Of particular benefit to single-ended converters and boost PFC topologies 150W and higher
- Low conduction losses and minimal minority-carrier recombination make these an excellent option for resonant mode switching as well (up to >>300 kHz)



### **Absolute Maximum Ratings**

	Parameter	Max.	Units
V <sub>CES</sub>	Collector-to-Emitter Breakdown Voltage	600	V
I <sub>C</sub> @ T <sub>C</sub> = 25°C	Continuous Collector Current	40	
I <sub>C</sub> @ T <sub>C</sub> = 100°C	Continuous Collector Current	20	Α
I <sub>CM</sub>	Pulsed Collector Current ①	160	
I <sub>LM</sub>	Clamped Inductive Load Current ②	160	
$V_{GE}$	Gate-to-Emitter Voltage	± 20	V
E <sub>ARV</sub>	Reverse Voltage Avalanche Energy 3	160	mJ
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Maximum Power Dissipation	160	W
P <sub>D</sub> @ T <sub>C</sub> = 100°C	Maximum Power Dissipation	65	
T <sub>J</sub>	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		∞
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from case )	7
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case		0.77	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
R <sub>eJA</sub>	Junction-to-Ambient, typical socket mount		40	
Wt	Weight	6 (0.21)		g (oz)

## IRG4PC40WPbF

## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions	
V <sub>(BR)CES</sub>	Collector-to-Emitter Breakdown Voltage	600	_	_	V	$V_{GE} = 0V, I_{C} = 250\mu A$	
V <sub>(BR)ECS</sub>	Emitter-to-Collector Breakdown Voltage ④	18	_	_	V	$V_{GE} = 0V$ , $I_C = 1.0A$	
$\Delta V_{(BR)CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	_	0.44	_	V/°C	$V_{GE} = 0V, I_{C} = 1.0mA$	
		_	2.05	2.5		I <sub>C</sub> = 20A	V <sub>GE</sub> = 15V
V <sub>CE(ON)</sub>	Collector-to-Emitter Saturation Voltage	_	2.36	_	<sub>v</sub>	$I_C = 40A$	See Fig.2, 5
		_	1.90	_		$I_C = 20A$ , $T_J = 150^{\circ}C$	
V <sub>GE(th)</sub>	Gate Threshold Voltage	3.0	—	6.0		$V_{CE}=V_{GE},I_{C}=250\mu A$	
$\Delta V_{GE(th)}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	_	13	_	mV/°C	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	
9 <sub>fe</sub>	Forward Transconductance §	18	28	_	S	$V_{CE} = 100 \text{ V}, I_{C} = 20 \text{A}$	
I <sub>CES</sub>	Zero Gate Voltage Collector Current	_	_	250	μA	$V_{GE} = 0V, V_{CE} = 600V$	
*CES	2010 Gate Voltage Collecter Carrell	_	_	2.0	"	$V_{GE} = 0V, V_{CE} = 10V, T_{CE}$	<sub>J</sub> = 25°C
		_	_	2500		$V_{GE} = 0V, V_{CE} = 600V,$	Γ <sub>J</sub> = 150°C
IGES	Gate-to-Emitter Leakage Current	_	_	±100	nΑ	$V_{GE} = \pm 20V$	

## Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Qg	Total Gate Charge (turn-on)	_	98	147		I <sub>C</sub> = 20A
Q <sub>ge</sub>	Gate - Emitter Charge (turn-on)		12	18	nC	V <sub>CC</sub> = 400V See Fig.8
Q <sub>gc</sub>	Gate - Collector Charge (turn-on)	T -	36	54		V <sub>GE</sub> = 15V
t <sub>d(on)</sub>	Turn-On Delay Time	T -	27	_		
t <sub>r</sub>	RiseTime		22	_	ns	$T_J = 25^{\circ}C$
t <sub>d(off)</sub>	Turn-Off Delay Time		100	150	115	$I_C = 20A$ , $V_{CC} = 480V$
t <sub>f</sub>	FallTime	T -	74	110		$V_{GE}$ = 15V, $R_{G}$ = 10 $\Omega$
E <sub>on</sub>	Turn-On Switching Loss		0.11	_		Energy losses include "tail"
E <sub>off</sub>	Turn-Off Switching Loss		0.23	_	mJ	See Fig. 9,10, 14
E <sub>ts</sub>	Total Switching Loss		0.34	0.45		
t <sub>d(on)</sub>	Turn-On Delay Time		25	_		T <sub>J</sub> = 150°C,
t <sub>r</sub>	RiseTime		23	_	ns	$I_C = 20A$ , $V_{CC} = 480V$
t <sub>d(off)</sub>	Turn-Off Delay Time		170	_	113	$V_{GE} = 15V$ , $R_G = 10\Omega$
t <sub>f</sub>	FallTime		124	<b>—</b>		Energy losses include "tail"
Ets	Total Switching Loss		0.85	_	mJ	See Fig.10,11, 14
LE	Internal Emitter Inductance		13	_	nΗ	Measured 5mm from package
Cies	Input Capacitance		1900	_		$V_{GE} = 0V$
Coes	Output Capacitance		140	<b>—</b>	рF	V <sub>CC</sub> = 30V See Fig. 7
C <sub>res</sub>	Reverse Transfer Capacitance		35	_		f = 1.0MHz

#### Notes:

- 1 Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- $\textcircled{2}~~V_{CC}$  = 80%(V\_{CES}), V\_{GE} = 20V, L = 10µH, R\_G = 10Ω, (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- 4 Pulse width  $\leq$  80µs; duty factor  $\leq$  0.1%.
- ⑤ Pulse width 5.0µs, single shot.

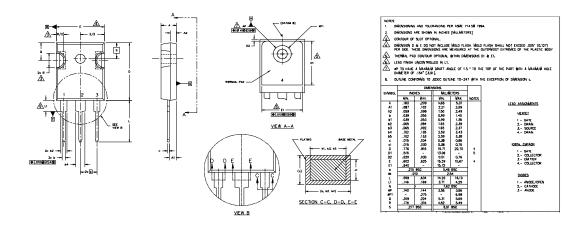
## IRG4PC40WPbF

International

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## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



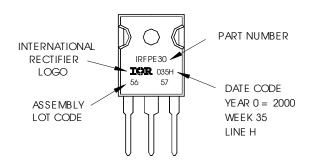
## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30

WITH ASSEMBLY LOT CODE 5657

ASSEMBLED ON WW 35, 2000 IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

